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TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE
ORIGINAL DOCUMENTS OR COPY THEREOF. PLEASE RECORD THE ATTACHED

1. Name of conveying party(ies):

(a) Byung Joon Han

Additional name(s) of conveying party(ies) attached?
 Yes No

3.4.02

2. Name and address of receiving party(ies):

Name: Amkor Technology, Inc.
Street Address: 1900 South Price Road
City: Chandler AZ 85248-1604
Country: U.S.A.

3. Nature of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other
Execution Date: January 15, 2002

Name and address of receiving party(ies):

Name: {Enter Name}
Street Address: {Enter Street Address}
City: {City} State: {State} Zip: {Zip}
Country: {Country}
Additional name(s) & address(es) attached?
 Yes No

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) - 09/745,265, filed December 20, 2000
Title: Wire Bonding Method And Semiconductor Package
Manufactured Using The Same

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: James E. Parsons
Internal Address: SKJERVEN MORRILL MacPHERSON LLP
Street Address: 25 METRO DRIVE, SUITE 700
City: SAN JOSE State: CA Zip: 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00
 Authorized to be charged to Deposit Account 19-2386
 Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James E. Parsons 34,691
Name of Person Signing

James E. Parsons
Signature

2/19/02
Date

Total number of pages including cover sheet, attachments, and documents: 3

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

| | | |
|-----------------------|----|---------------------------------|
| <u>Young Kuk Park</u> | of | <u>Seoul, Republic of Korea</u> |
| <u>Byung Joon Han</u> | of | <u>Singapore</u> |
| <u>Jae Dong Kim</u> | of | <u>Tempe, AZ</u> |

hereby sell, assign and transfer to Amkor Technology, Inc., a Delaware corporation, having a place of business at 1900 South Price Road, Chandler, AZ 85248-1604, its successors and assigns, the entire right, title and interest throughout the world in our invention in

Wire Bonding Method And Semiconductor Package Manufactured Using The Same

for which we filed a United States Patent Application on December 20, 2000, which now has Serial No. 09/745,265, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this ____ day of _____, 2001.

Young Kuk Park

WITNESSED:

Signature

Date

Type or print name of witness

Executed this 15 day of January, 2002.
[Signature]
Byung Joon Han

WITNESSED:

Signature [Signature]
Date 15 Jan 2002
Type or print name of witness Looi Lee Hwa

Executed this _____ day of _____, 2001.

Jae Dong Kim

State of _____)
County of _____) ss.

On _____ before me, _____
personally appeared _____ personally
known to me or proved to me on the basis of satisfactory evidence to be the person(s) whose
name(s) is(are) subscribed to the within instrument and acknowledged to me that he/she/they
executed the same in his/her/their authorized capacity(ies), and that by his/her/their
signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s)
acted, executed the instrument.

WITNESS my hand and official seal.

SIGNATURE OF NOTARY